10/634,174

**PATENT** 

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant:

Leonard Forbes

Examiner: Joannie A. Garcia

Serial No.:

10/634,174

Group Art Unit: 2823

Filed:

August 5, 2003

Docket: 1303.102US1

Title:

STRAINED SI/SIGE/SOI ISLANDS AND PROCESSES OF MAKING SAME

## COMMUNICATION CONCERNING RELATED APPLICATIONS

## MS RCE

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Applicant would like to bring to the Examiner's attention the following related applications in the above-identified patent application:

Serial/Patent No. 11318124	Filing Date/Issue Date December 23, 2005	Attorney Docket 1303.095US3	Title STRAINED SEMICONDUCTOR BY WAFER BONDING WITH MISORIENTATION
11432578	May 11, 2006	1303.100US3	MICROMECHANICAL STRAINED SEMICONDUCTOR BY WAFER BONDING
11475798	June 27, 2006	1303.109US2	STRAINED SEMICONDUCTOR BY FULL WAFER BONDING

Continuations and divisionals may be later filed on the cases listed above, or cited to the Examiner in any previous Communication Concerning Related Applications. Applicants request that the Examiner review all continuations and divisionals of the above-listed or previously-cited patent applications before allowing the claims of the present patent application.

Respectfully submitted, LEONARD FORBES

By Applicant's Representatives, SCHWEGMAN, LUNDBERG, WOESSNER & KLUTH, P.A. P.O. Box 2938 Minneapolis, MN 55402 (612) 373-6960

Date 7./9.06

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<u>CERTIFICATE UNDER 37 CFR 1.8:</u> The undersigned hereby certifies that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail, in an envelope addressed to: MS RCE, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on this \_\_\_\_\_ day of <u>July</u>, 2006.

Name

Signature